

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

NI

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{\text{DS(on)1}}$ = 39 m Ω MAX. (Vgs = 10 V, ID = 11 A)

- Low C_{iss} : C_{iss} = 590 pF TYP.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage	Vdss	55	V
	Gate to Source Voltage	Vgss	±20	V
	Drain Current (DC)	D(DC)	±22	А
k	Drain Current (Pulse) ^{Note1}	D(pulse)	±55	А
	Total Power Dissipation ($T_A = 25^{\circ}C$)	Р⊤	1.2	W
	Total Power Dissipation ($Tc = 25^{\circ}C$)	Pτ	45	W
	Single Avalanche Current Note2	las	13 / 5	А
	Single Avalanche Energy Note2	Eas	16 / 25	mJ
	Channel Temperature	Tch	175	°C
	Storage Temperature	Tstg	–55 to +175	°C

Notes 1. PW \leq 10 $\mu s,$ Duty cycle \leq 1 %

2. Starting $T_{ch} = 25^{\circ}C$, $R_G = 25 \Omega$, $V_{GS} = 20 V \rightarrow 0 V$ (See Figure 4.)

THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	3.33	°C/W
Channel to Ambient	Rth(ch-A)	125	°C/W

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP22N055HHE	TO-251
NP22N055IHE	TO-252



(TO-251)

(TO-252)



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UNIT mΩ V S μA μA pF pF ns

> ns ns nC nC nC V

ns

nC

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 11 A		30	39
Gate to Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.0	3.0	4.0
Forward Transfer Admittance	yfs	Vds = 10 V, Id = 11 A	4	8	
Drain Leakage Current	IDSS	$V_{DS} = 55 V, V_{GS} = 0 V$			10
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20 V$, $V_{DS} = 0 V$			±10
Input Capacitance	Ciss	$V_{DS} = 25 V$, $V_{GS} = 0 V$, $f = 1 MHz$		590	890
Output Capacitance	Coss			110	170
Reverse Transfer Capacitance	Crss			52	94
Turn-on Delay Time	td(on)	$I{\rm D}=11A,V{\rm GS(on)}=10V,V{\rm DD}=28V,$		11	24
Rise Time	tr	R _G = 1 Ω		6.0	15
Turn-off Delay Time	td(off)			25	49
Fall Time	tr			6.6	17
Total Gate Charge	QG	$I_D = 22 A, V_{DD} = 44 V, V_{GS} = 10 V$		12	18
Gate to Source Charge	Q _{GS}			3	
Gate to Drain Charge	Qgd			5	
Body Diode Forward Voltage	VF(S-D)	IF = 22 A, VGS = 0 V		1.0	

trr

Qrr

TEST CIRCUIT 1 AVALANCHE CAPABILITY

Reverse Recovery Time

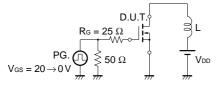
Reverse Recovery Charge

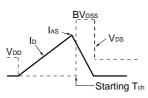
TEST CIRCUIT 2 SWITCHING TIME

D.U.T.

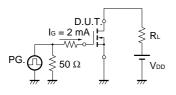
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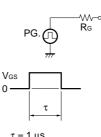
 $I_F = 22 \text{ A}, \text{ V}_{GS} = 0 \text{ V}, \text{ di/dt} = 100 \text{ A}/\mu \text{ s}$



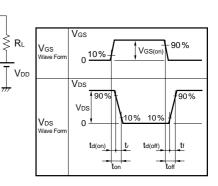


TEST CIRCUIT 3 GATE CHARGE





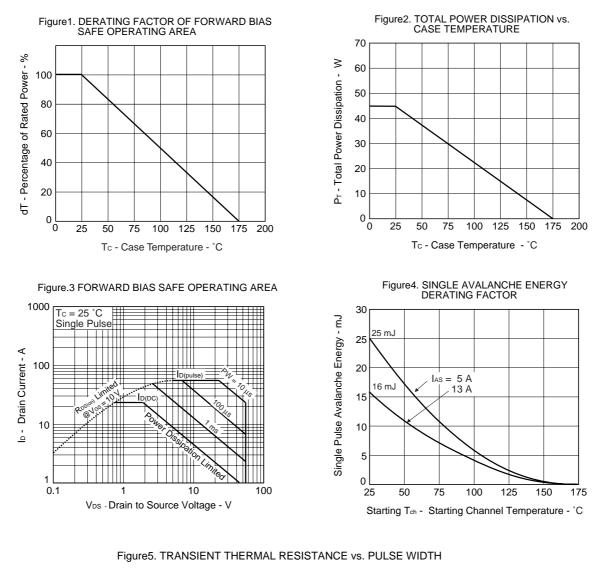


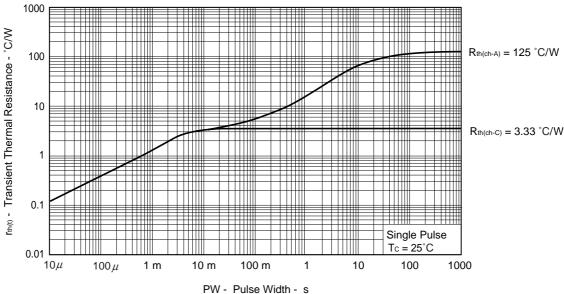


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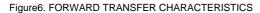
42

★ TYPICAL CHARACTERISTICS (TA = $25 \degree$ C)

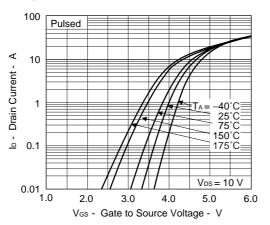




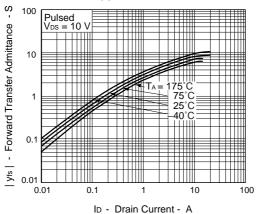
Data Sheet D14135EJ2V0DS00

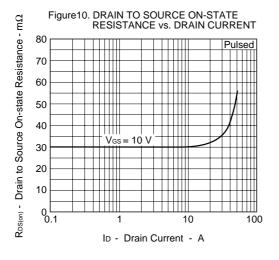


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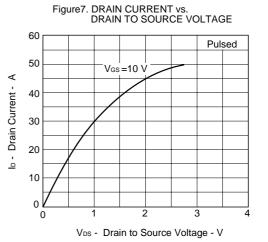
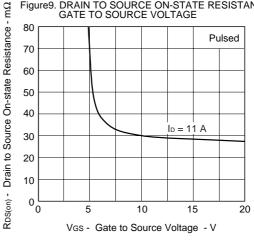
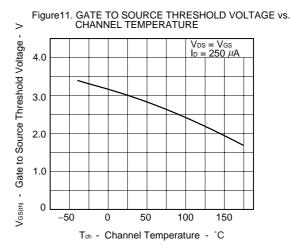


Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

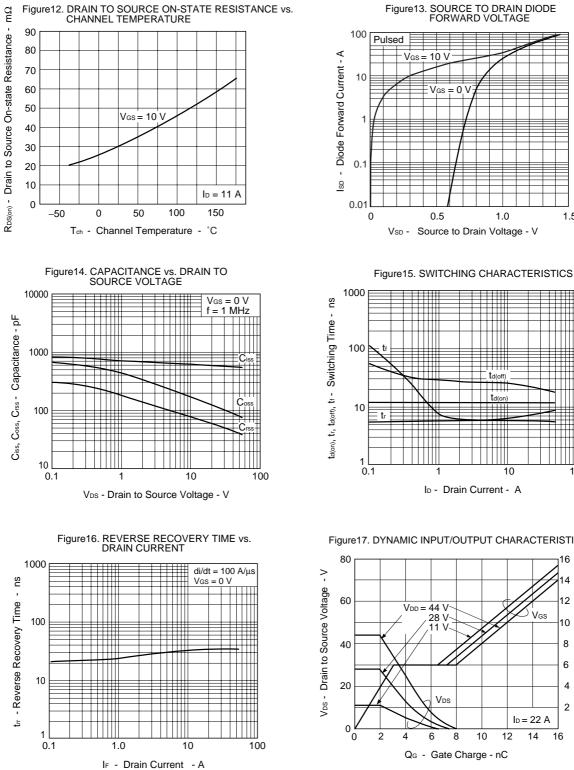




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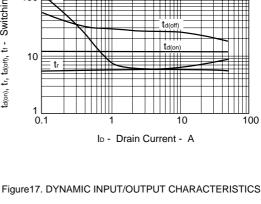
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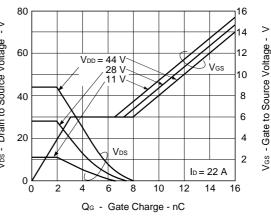
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Figure 13. SOURCE TO DRAIN DIODE FORWARD VOLTAGE

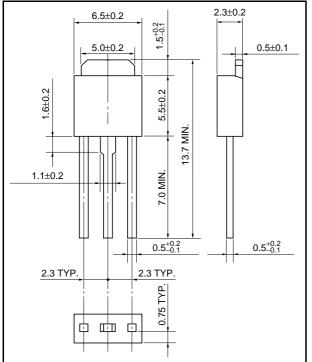


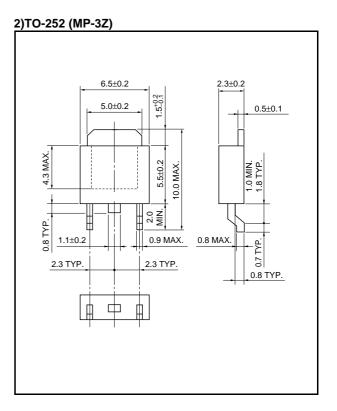


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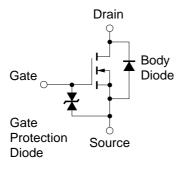
* PACKAGE DRAWINGS (Unit: mm)

1)TO-251 (MP-3)





EQUIVALENT CIRCUIT



Remark 1. These products are an electrostatic sensitive device. Please handle with caution.

2. The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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